## **Special Issue**

### Selected Papers from 2021 International Conference on Biomedical Science and Bioinformatics

### Message from the Guest Editor

ICBSB 2021 is hosted by Hubei Zhongke Geological and Environmental Technology Service Center, China. 2021 International Conference on Biomedical Science and Bioinformatics [ICBSB2021] will be held on December 16th-18th, 2021 in Wuhan, China. ICBSB2021 is a leading annual conference of Biomedical Science and Bioinformatics for all researchers home and abroad. The aim of the conference is to provide a platform to the global researchers and practitioners from both academia as well as industry to meet and share cuttingedge development in the field. On behalf of the organizing committee, we'd like to send our honest invitation to all distinguished scholars and engineers. Conference link: https://www.icbsb.com/

### Guest Editor

Prof. Dr. Hong Lin Department of Computer Science and Engineering Technology, University of Houston-Downtown, Houston, TX, USA

### Deadline for manuscript submissions

closed (15 February 2022)



## Applied Sciences

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### Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

#### Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

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